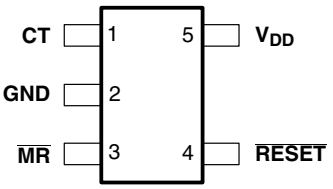
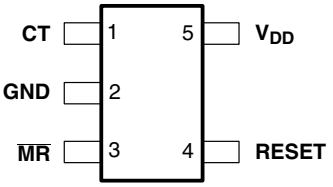
- **Qualified for Automotive Applications**
- **Customer-Specific Configuration Control Can Be Supported Along With Major-Change Approval**
- **ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)**
- **Supply Current of 220 nA (Typ)**
- **Precision Supply Voltage Supervision Range: 1.8 V, 2.5 V, 3.0 V, 3.3 V**
- **Power-On Reset Generator With Selectable Delay Time of 10 ms or 200 ms**
- **Push/Pull $\overline{\text{RESET}}$ Output (TPS3836), RESET Output (TPS3837), or Open-Drain $\overline{\text{RESET}}$ Output (TPS3838)**
- **Manual Reset**
- **5-Pin SOT-23 Package**
- **Temperature Range: –40°C to 125°C**

- **Applications Include**
  - **Applications Using Automotive Low-Power DSPs, Microcontrollers, or Microprocessors**
  - **Battery-Powered Equipment**
  - **Intelligent Instruments**
  - **Wireless Communication Systems**
  - **Automotive Systems**

TPS3836, TPS3838
DBV PACKAGE
(TOP VIEW)



TPS3837
DBV PACKAGE
(TOP VIEW)



description

The TPS3836, TPS3837, TPS3838 families of supervisory circuits provide circuit initialization and timing supervision, primarily for DSP and processor-based systems.

During power on, $\overline{\text{RESET}}$ is asserted when the supply voltage V_{DD} becomes higher than 1.1 V. Thereafter, the supervisory circuit monitors V_{DD} and keeps $\overline{\text{RESET}}$ output active as long as V_{DD} remains below the threshold voltage V_{IT}. An internal timer delays the return of the output to the inactive state (high) to ensure proper system reset. The delay time starts after V_{DD} has risen above the threshold voltage V_{IT}.

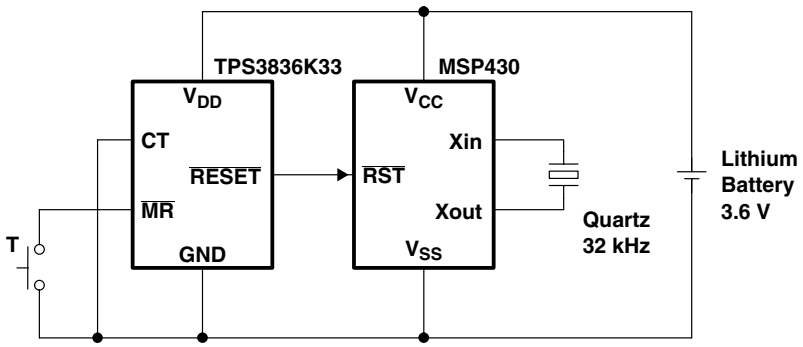
When CT is connected to GND a fixed delay time of typical 10 ms is asserted. When connected to V_{DD} the delay time is typically 200 ms.

When the supply voltage drops below the threshold voltage V_{IT}, the output becomes active (low) again.

All the devices of this family have a fixed-sense threshold voltage V_{IT} set by an internal voltage divider.

The TPS3836 has an active-low push-pull $\overline{\text{RESET}}$ output. The TPS3837 has active-high push-pull RESET, and TPS3838 integrates an active-low open-drain $\overline{\text{RESET}}$ output.

description (continued)



TYPICAL OPERATING CIRCUIT

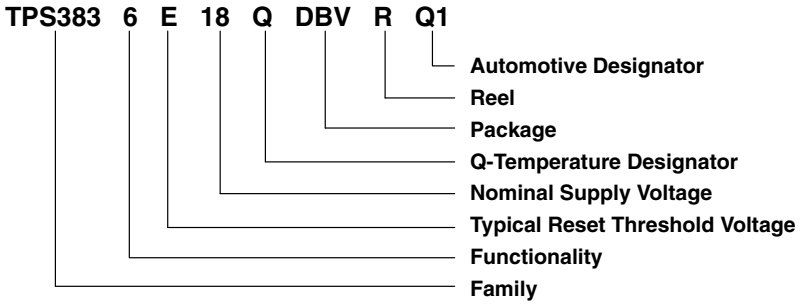
The product spectrum is designed for supply voltages of 1.8 V, 2.5 V, 3 V, and 3.3 V. The circuits are available in a 5-pin SOT-23 package. The TPS3836-Q-Q1, TPS3837-Q-Q1, TPS3838-Q-Q1 families are characterized for operation over a temperature range of –40°C to 125°C.

PACKAGE INFORMATION

T_A	DEVICE NAME	THRESHOLD VOLTAGE	SYMBOL
–40°C to 125°C	TPS3836E18QDBVRQ1†	1.71 V	PDNQ
	TPS3836J25QDBVRQ1†	2.25 V	PDSQ
	TPS3836H30QDBVRQ1†	2.79 V	PHRQ
	TPS3836L30QDBVRQ1†	2.64 V	PCAQ
	TPS3836K33QDBVRQ1†	2.93 V	PDTQ
	TPS3837E18QDBVRQ1†	1.71 V	PDOQ
	TPS3837J25QDBVRQ1†	2.25 V	PDRQ
	TPS3837L30QDBVRQ1†	2.64 V	PCBQ
	TPS3837K33QDBVRQ1†	2.93 V	PDUQ
	TPS3838E18QDBVRQ1†	1.71 V	PDQQ
	TPS3838J25QDBVRQ1†	2.25 V	PDPQ
	TPS3838L30QDBVRQ1†	2.64 V	PCCQ
	TPS3838K33QDBVRQ1†	2.93 V	PDVQ

† DBVR indicates tape and reel of 3000 parts.

ORDERING INFORMATION

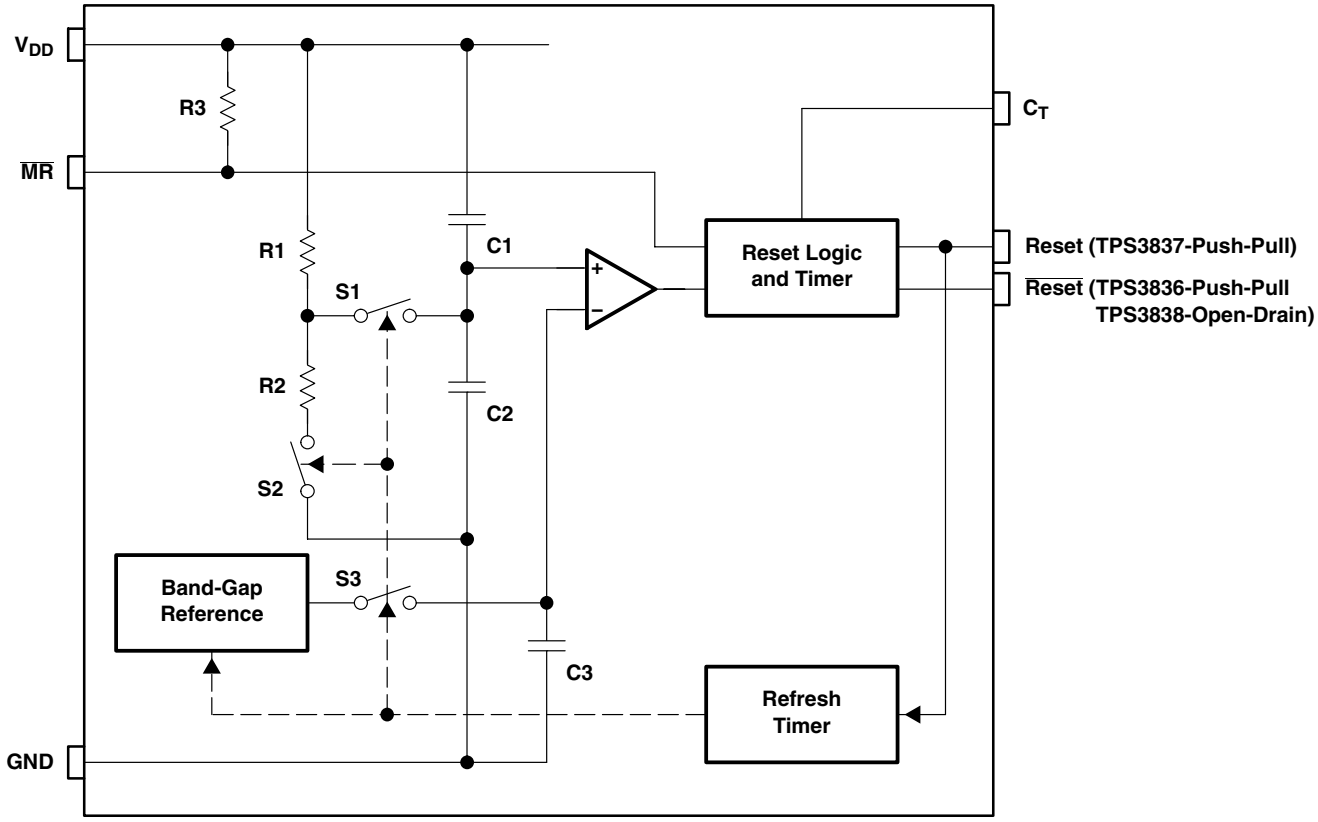


FUNCTION TABLE TPS3836, TPS3837, TPS3838

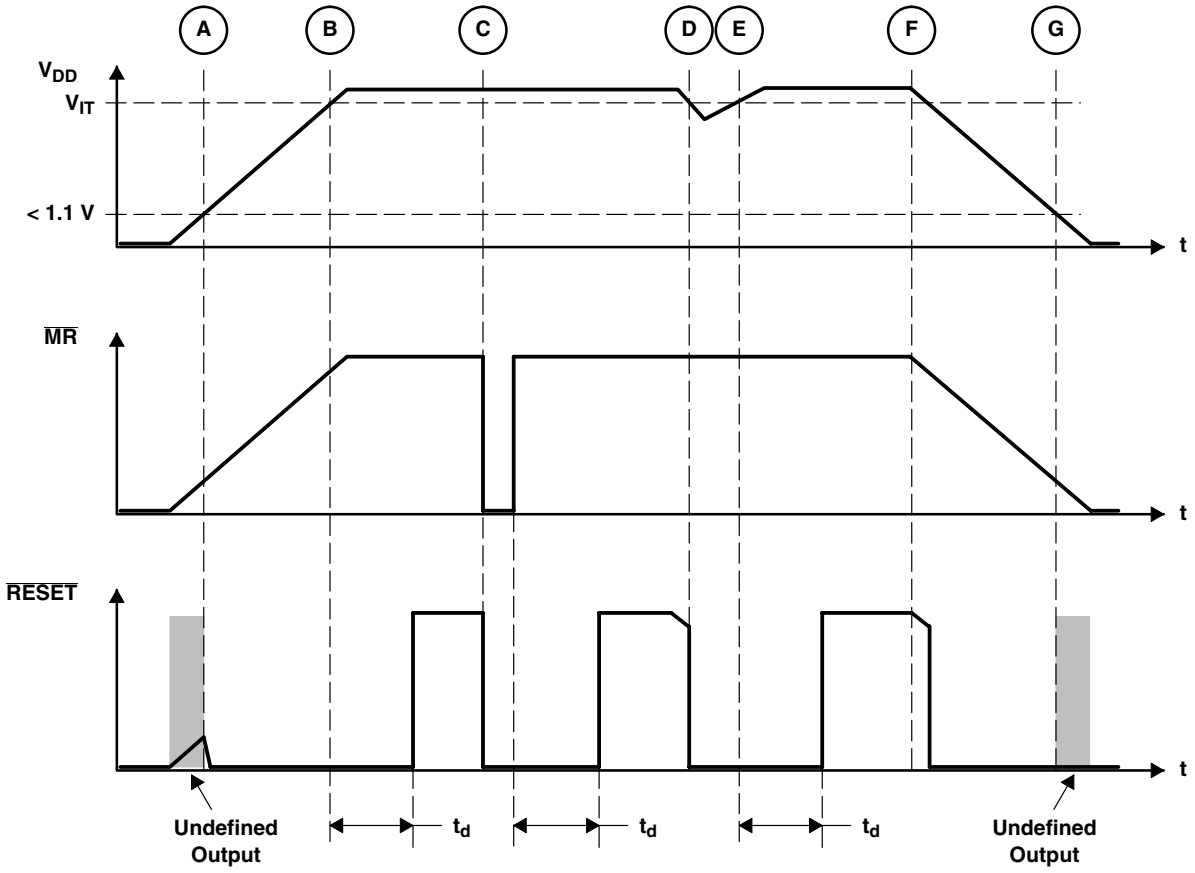
$\overline{MR}$	$V_{DD} > V_{IT}$	$\overline{RESET}$†	RESET‡
L	0	L	H
L	1	L	H
H	0	L	H
H	1	H	L

† TPS3836 and TPS3838
‡ TPS3837

functional block diagram



timing diagram



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V_{DD} (see Note 1) . . . . . 7 V
All other pins (see Note 1) . . . . . –0.3 V to 7 V
Maximum low output current, I_{OL} . . . . . 5 mA
Maximum high output current, I_{OH} . . . . . –5 mA
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{DD}$) . . . . . ±10 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{DD}$) . . . . . ±10 mA
Continuous total power dissipation . . . . . See Dissipation Rating Table
Operating free-air temperature range, T_A . . . . . –40°C to 125°C
Storage temperature range, T_{stg} . . . . . –65°C to 150°C
Soldering temperature . . . . . 260°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All voltage values are with respect to GND. For reliable operation, the device must not be operated at 7 V for more than t=1000 h continuously

DISSIPATION RATING TABLE

PACKAGE	T_A <25°C POWER RATING	DERATING FACTOR ABOVE T_A = 25°C	T_A = 70°C POWER RATING	T_A = 85°C POWER RATING	T_A = 125°C POWER RATING
DBV	437 mW	3.5 mW/ºC	280 mW	227 mW	87 mW

recommended operating conditions at specified temperature range

	MIN	MAX	UNIT
Supply voltage, V_{DD}	1.6	6	V
Input voltage, V_I	0	V_{DD} + 0.3	V
High-level input voltage, V_{IH}	$0.7 \times V_{DD}$		V
Low-level input voltage, V_{IL}		$0.3 \times V_{DD}$	V
Input transition rise and fall rate at $\overline{MR}$, $\Delta t/\Delta V$		100	ns/V
Operating free-air temperature range, T_A	–40	125	°C

electrical characteristics over recommended operating conditions (unless otherwise noted)

PARAMETER			TEST CONDITION		MIN	TYP	MAX	UNIT
V_{OH}	High-level output voltage	$\overline{\text{RESET}}$ (TPS3836)	V_{DD} = 3.3 V,	I_{OH} = –2 mA	0.8 × V_{DD}			V
			V_{DD} = 6 V,	I_{OH} = –3 mA				
		RESET (TPS3837)	V_{DD} = 1.8 V,	I_{OH} = –1 mA				
			V_{DD} = 3.3 V,	I_{OL} = –2 mA				
V_{OL}	Low-level output voltage	$\overline{\text{RESET}}$ (TPS3836/8)	V_{DD} = 1.8 V,	I_{OL} = 1 mA			0.4	V
			V_{DD} = 3.3 V,	I_{OL} = 2 mA				
		RESET (TPS3837)	V_{DD} = 3.3 V,	I_{OL} = 2 mA				
			V_{DD} = 6 V,	I_{OL} = 3 mA				
	Power-up reset voltage (see Note 2)	TPS3836/8	$V_{DD} \geq$ 1.1 V,	I_{OL} = 50 µA			0.2	V
		TPS3837	$V_{DD} \geq$ 1.1 V,	I_{OH} = –50 µA	0.8 × V_{DD}			
V_{IT}	Negative-going input threshold voltage (see Note 3)	TPS383xE18			1.64	1.71	1.76	V
		TPS383xJ25			2.16	2.25	2.30	
		TPS383xH30			2.70	2.79	2.85	
		TPS383xL30			2.54	2.64	2.71	
		TPS383xK33			2.82	2.93	3.10	
V_{hys}	Hysteresis at V_{DD} input		1.7 V < V_{IT} < 2.5 V			30		mV
			2.5 V < V_{IT} < 3.5 V			40		
			3.5 V < V_{IT} < 5 V			50		
I_{IH}	High-level input current	$\overline{\text{MR}}$ (see Note 4)	$\overline{\text{MR}}$ = 0.7 × V_{DD},	V_{DD} = 6 V	–40	–60	–100	µA
		CT	CT = V_{DD} = 6 V		–25		25	nA
I_{IL}	Low-level input current	$\overline{\text{MR}}$ (see Note 4)	$\overline{\text{MR}}$ = 0 V,	V_{DD} = 6 V	–130	–200	–340	µA
		CT	CT = 0 V,	V_{DD} = 6 V	–25		25	nA
I_{OH}	High-level output current	TPS3838	V_{DD} = V_{IT} + 0.2 V,	V_{OH} = V_{DD}			25	nA
I_{DD}	Supply current		V_{DD} > V_{IT},	V_{DD} < 3 V		220	500	nA
			V_{DD} > V_{IT},	V_{DD} > 3 V		250	550	
			V_{DD} < V_{IT}			10	25	µA
	Internal pullup resistor at $\overline{\text{MR}}$					30		kΩ
C_I	Input capacitance at $\overline{\text{MR}}$, CT		V_I = 0 V to V_{DD}			5		pF

NOTES: 2. The lowest voltage at which $\overline{\text{RESET}}$ output becomes active. t_r, $V_{DD} \geq$ 15 µs/V
3. To ensure best stability of the threshold voltage, a bypass capacitor (ceramic, 0.1 µF) should be placed near the supply terminal.
4. If manual reset is unused, $\overline{\text{MR}}$ should be connected to V_{DD} to minimize current consumption.

timing requirements at R_L = 1 MΩ, C_L = 50 pF, T_A = 25°C

PARAMETER			TEST CONDITIONS		MIN	TYP	MAX	UNIT
t_w	Pulse width	at V_{DD}	$V_{IH} = V_{IT} + 0.2$ V,	$V_{IL} = V_{IT} - 0.2$ V	6			µs
		at $\overline{MR}$	$V_{DD} \geq V_{IT} + 0.2$ V, $V_{IH} = 0.7 \times V_{DD}$	$V_{IL} = 0.3 \times V_{DD}$,	1			µs

switching characteristics at R_L = 1 MΩ, C_L = 50 pF, T_A = 25°C

PARAMETER			TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_d	Delay time		$V_{DD} \geq V_{IT} + 0.2$ V, $\overline{MR} = 0.7 \times V_{DD}$, CT = GND, See timing diagram	5	10	15	ms
			$V_{DD} \geq V_{IT} + 0.2$ V, $\overline{MR} = 0.7 \times V_{DD}$, CT = V_{DD} , See timing diagram	100	200	300	
t_{PHL}	Propagation (delay) time, high-to-low-level output	V_{DD} to $\overline{RESET}$ delay (TPS3836, TPS3838)	$V_{IL} = V_{IT} - 0.2$ V, $V_{IH} = V_{IT} + 0.2$ V			10	µs
			V_{IL} = 1.6 V			50	
t_{PLH}	Propagation (delay) time, low-to-high-level output	V_{DD} to RESET delay (TPS3837)	$V_{IL} = V_{IT} - 0.2$ V, $V_{IH} = V_{IT} + 0.2$ V			10	µs
			V_{IL} = 1.6 V			50	
t_{PHL}	Propagation (delay) time, high-to-low-level output	$\overline{MR}$ to $\overline{RESET}$ delay (TPS3836, TPS3838)	$V_{DD} \geq V_{IT} + 0.2$ V, $V_{IL} = 0.3 \times V_{DD}$, $V_{IL} = 0.7 \times V_{DD}$			0.1	µs
t_{PLH}	Propagation (delay) time, low-to-high-level output	$\overline{MR}$ to RESET delay (TPS3837)				0.1	µs

TYPICAL CHARACTERISTICS

Table of Graphs

			FIGURE
I_{DD}	Supply current	vs Supply voltage	1
I_{MR}	Manual reset current	vs Manual reset voltage	2
V_{OL}	Low-level output voltage	vs Low-level output current	3
V_{OH}	High-level output voltage	vs High-level output current	4
	Normalized reset threshold voltage	vs Free-air temperature	5
	Minimum pulse duration at V_{DD}	vs V_{DD} Threshold overdrive	6

TYPICAL CHARACTERISTICS

SUPPLY CURRENT vs SUPPLY VOLTAGE

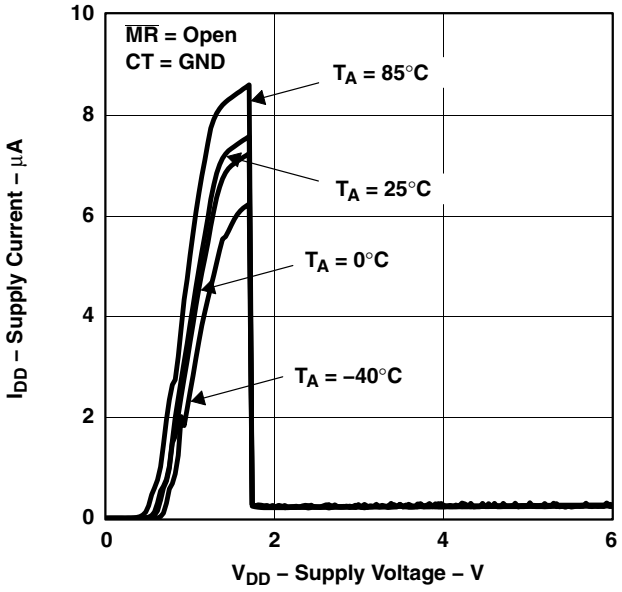


Figure 1

MANUAL RESET CURRENT vs MANUAL RESET VOLTAGE

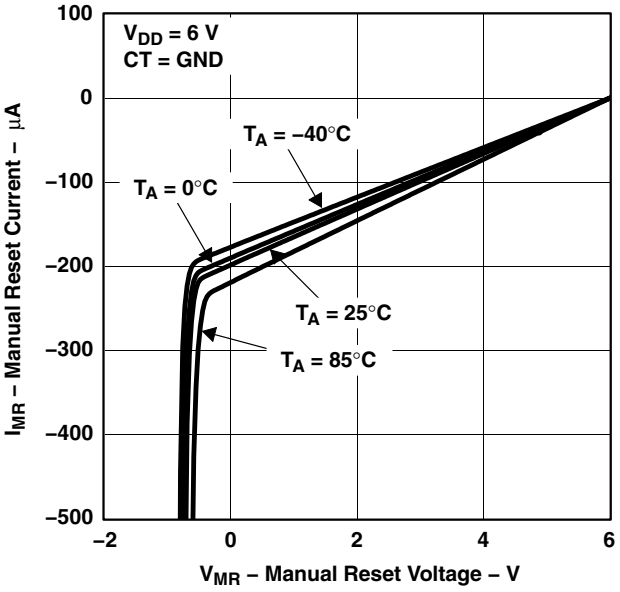


Figure 2

LOW-LEVEL OUTPUT VOLTAGE vs LOW-LEVEL OUTPUT CURRENT

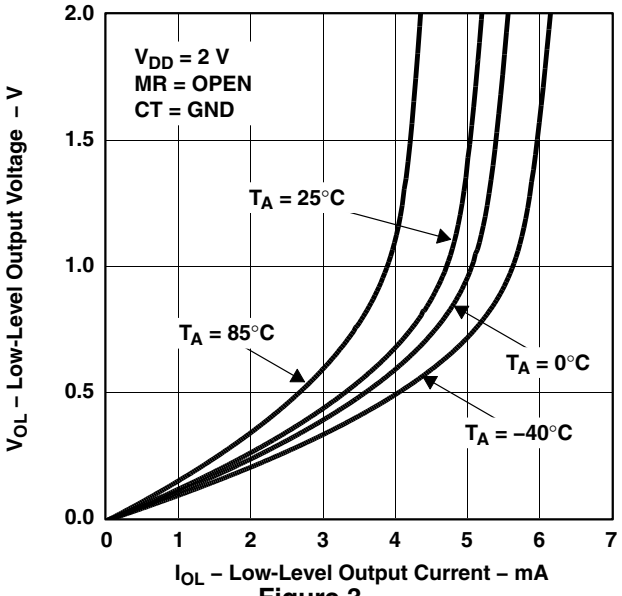


Figure 3

HIGH-LEVEL OUTPUT VOLTAGE vs HIGH-LEVEL OUTPUT CURRENT

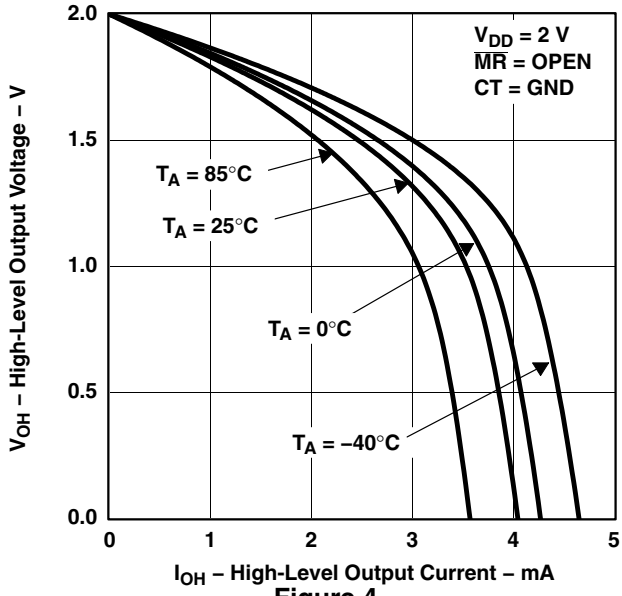


Figure 4

TYPICAL CHARACTERISTICS

NORMALIZED RESET THRESHOLD VOLTAGE vs FREE-AIR TEMPERATURE

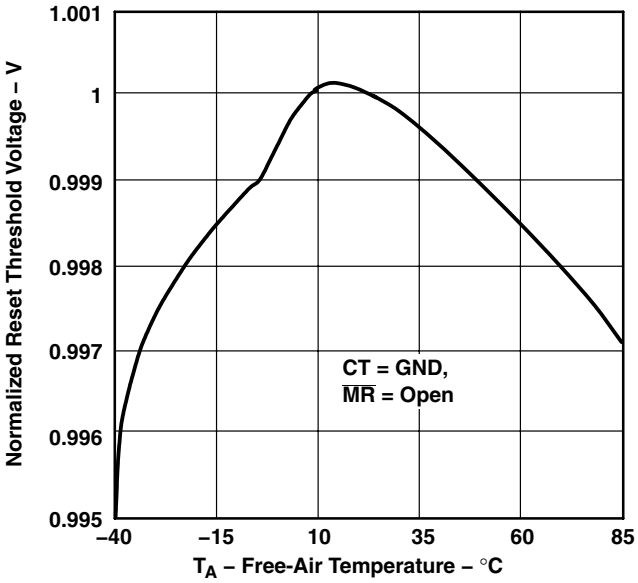


Figure 5

MINIMUM PULSE DURATION AT V_{DD} vs V_{DD} THRESHOLD OVERDRIVE

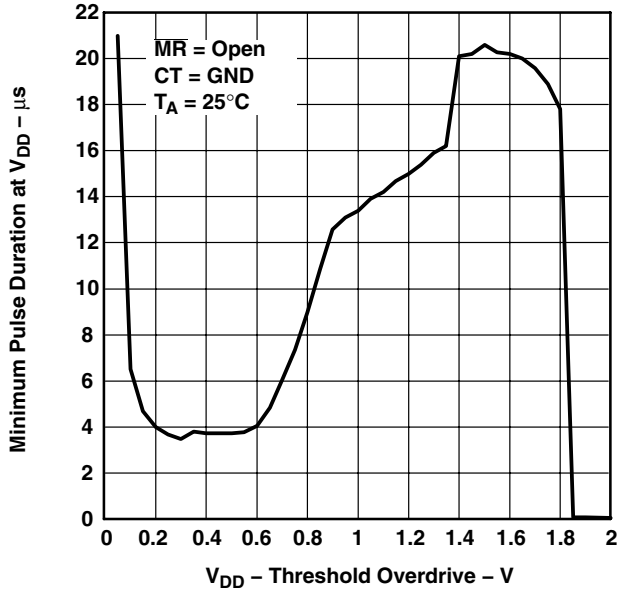


Figure 6

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
TPS3836J25QDBVRQ1	ACTIVE	SOT-23	DBV	5	3000	RoHS & Green	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 125	PDSQ	Samples
TPS3836K33QDBVRQ1	ACTIVE	SOT-23	DBV	5	3000	RoHS & Green	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 125	PDTQ	Samples
TPS3836L30QDBVRQ1	ACTIVE	SOT-23	DBV	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PCAQ	Samples
TPS3838K33QDBVRQ1	ACTIVE	SOT-23	DBV	5	3000	RoHS & Green	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 125	PDVQ	Samples

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.
Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF TPS3836-Q1, TPS3838-Q1 :

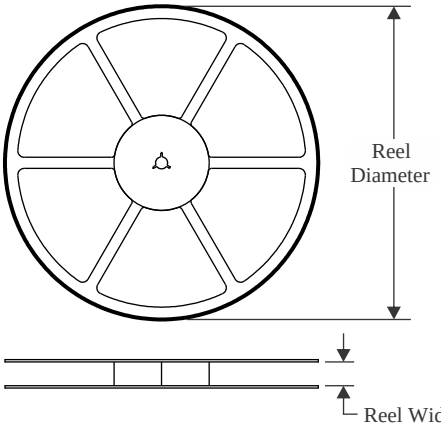
- Catalog : TPS3836, TPS3838
- Enhanced Product : TPS3836-EP

NOTE: Qualified Version Definitions:

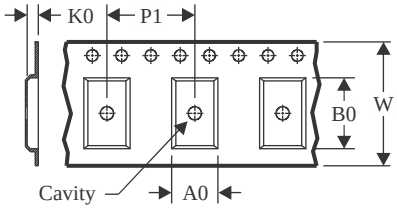
- Catalog - TI's standard catalog product
- Enhanced Product - Supports Defense, Aerospace and Medical Applications

TAPE AND REEL INFORMATION

REEL DIMENSIONS

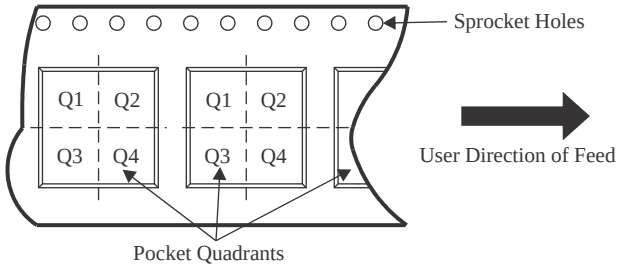


TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

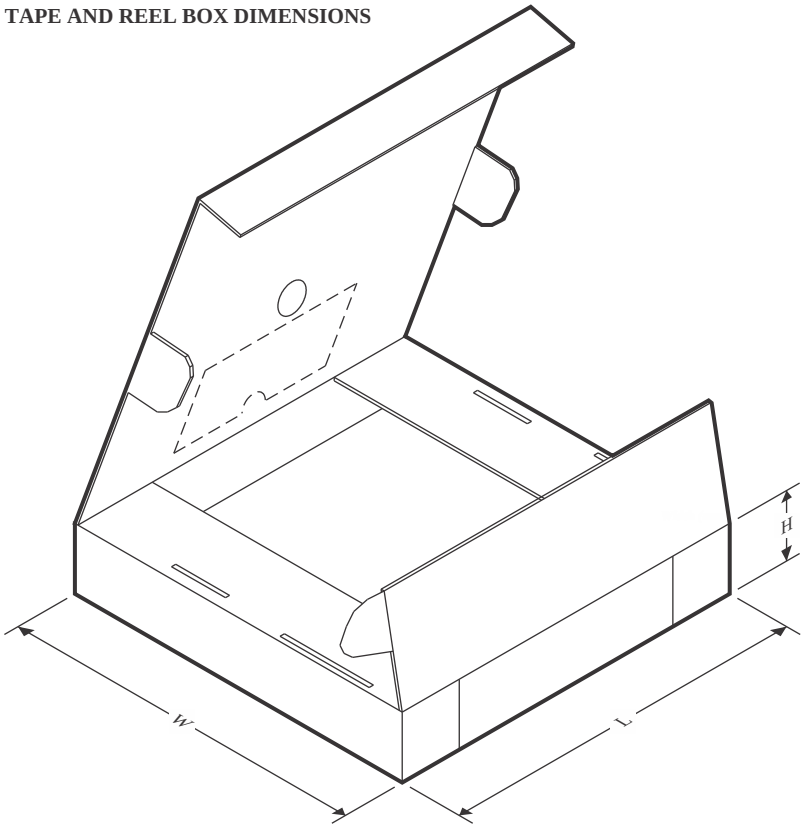
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS3836J25QDBVRQ1	SOT-23	DBV	5	3000	180.0	9.0	3.15	3.2	1.4	4.0	8.0	Q3
TPS3836K33QDBVRQ1	SOT-23	DBV	5	3000	180.0	9.0	3.15	3.2	1.4	4.0	8.0	Q3
TPS3836L30QDBVRQ1	SOT-23	DBV	5	3000	180.0	9.0	3.15	3.2	1.4	4.0	8.0	Q3
TPS3838K33QDBVRQ1	SOT-23	DBV	5	3000	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS3838K33QDBVRQ1	SOT-23	DBV	5	3000	180.0	9.0	3.15	3.2	1.4	4.0	8.0	Q3

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

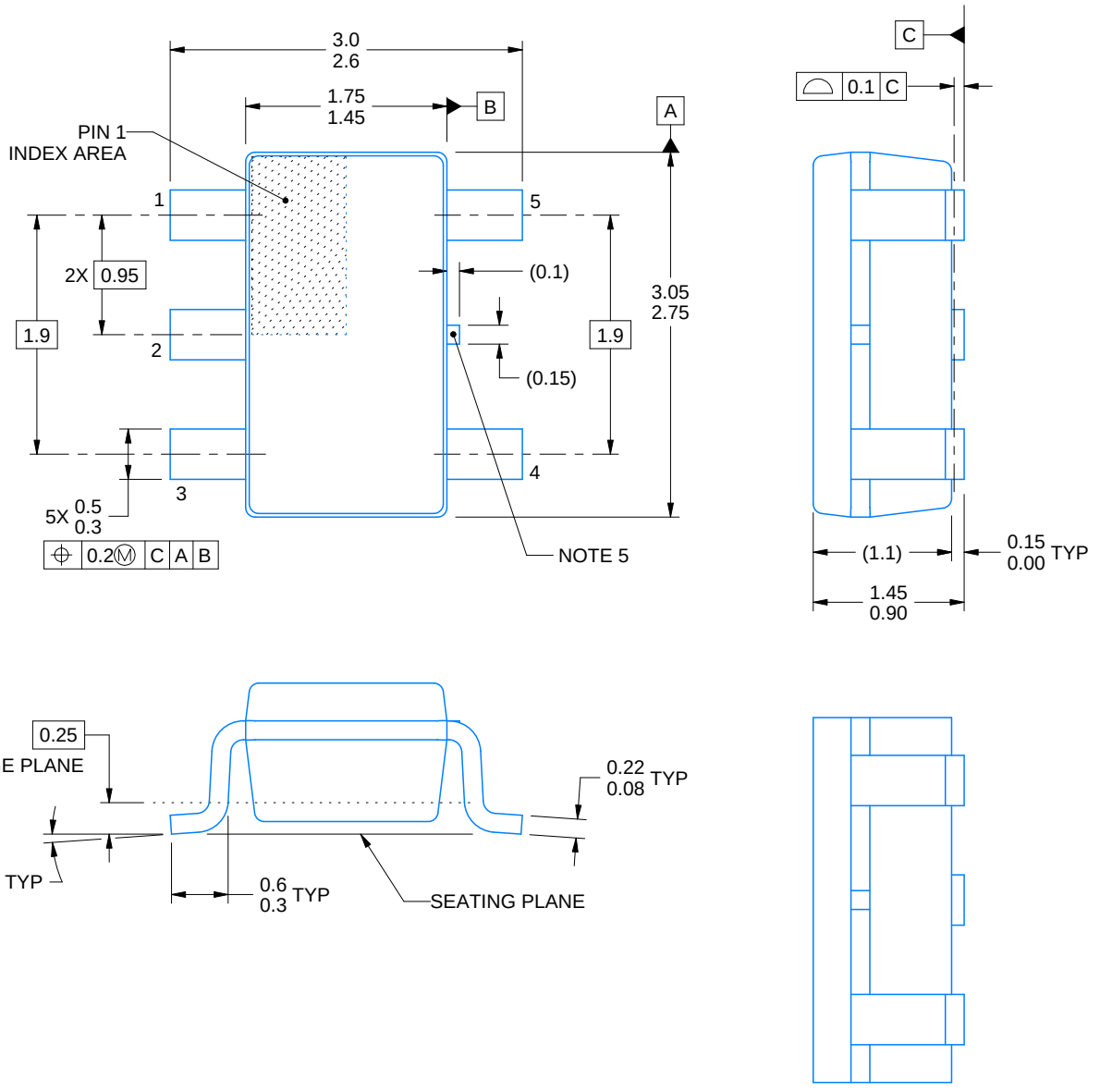
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS3836J25QDBVRQ1	SOT-23	DBV	5	3000	182.0	182.0	20.0
TPS3836K33QDBVRQ1	SOT-23	DBV	5	3000	182.0	182.0	20.0
TPS3836L30QDBVRQ1	SOT-23	DBV	5	3000	182.0	182.0	20.0
TPS3838K33QDBVRQ1	SOT-23	DBV	5	3000	210.0	185.0	35.0
TPS3838K33QDBVRQ1	SOT-23	DBV	5	3000	182.0	182.0	20.0

PACKAGE OUTLINE

DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR

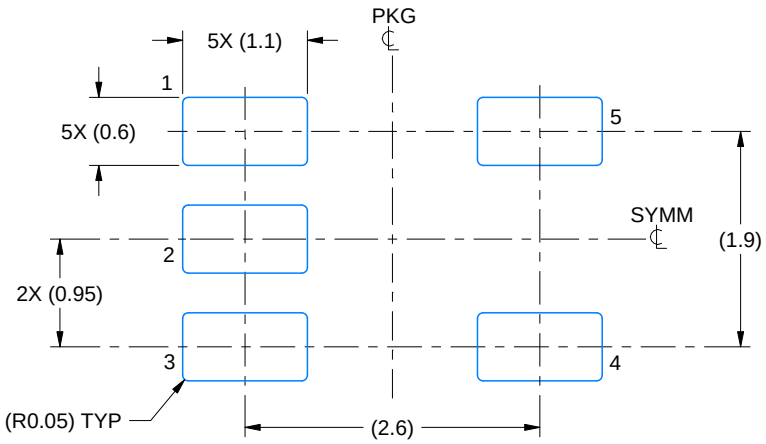


ALTERNATIVE PACKAGE SINGULATION VIEW

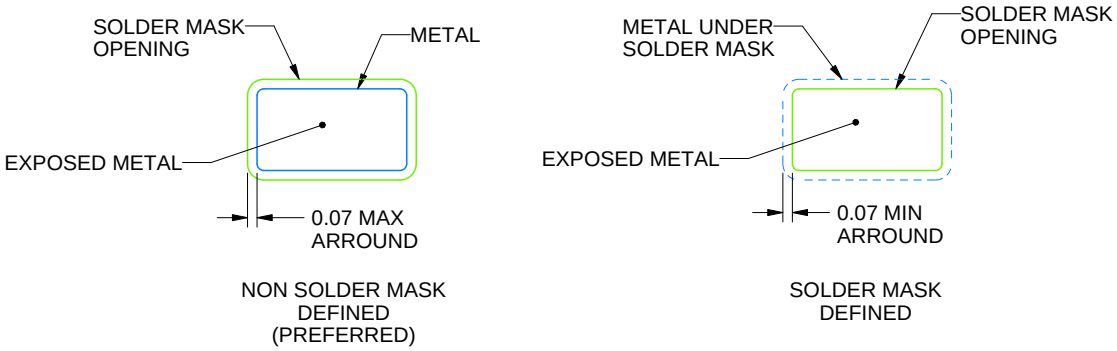
4214839/J 02/2024

NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Refernce JEDEC MO-178.
4. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25 mm per side.
5. Support pin may differ or may not be present.



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:15X

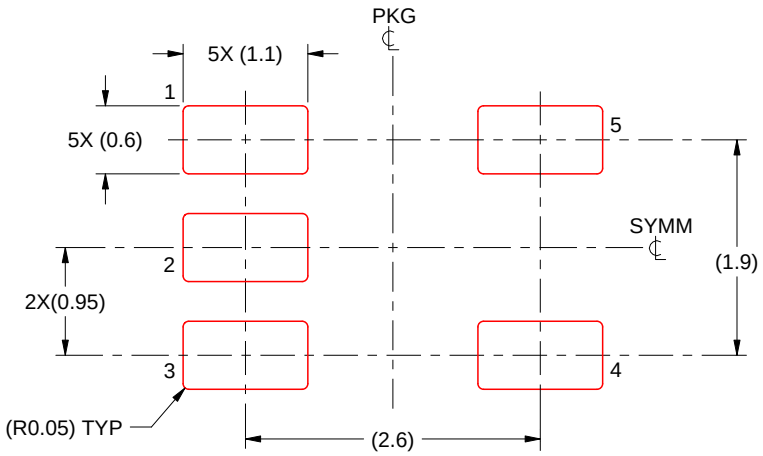


SOLDER MASK DETAILS

4214839/J 02/2024

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:15X

4214839/J 02/2024

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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